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**USB CONNECTOR, PLUG TYPE.**

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**1. SCOPE**

This specification covers performance, tests and quality requirements for **USB CONNECTOR, PLUG TYPE** connector.

**2. APPLICABLE DOCUMENT**

The following documents form a part of this specification to the extent specified herein. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

Test Report : 501-57337

**3. REQUIREMENTS**

**3.1. DESIGN AND CONSTRUCTION**

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

**3.2. MATERIALS**

A. Housing: Thermoplastic, UL 94V-0, Color: Black.

B. Contact: Copper Alloy, Gold plating on contact area, Tin-lead or Tin plated on soldertails, Nickel underplated all over.

**3.3. RATING :**

A. Current Rating: 1.5 A

B. Voltage Rating: 30 VDC

C. Operating temperature : 0°C to + 50°C.

**3.4. TEST CONDITION:**

The product is designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1.

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### 3.5. TEST REQUIREMENTS AND PROCEDURES SUMMARY

TEST DESCRIPTION	REQUIREMENT	PROCEDURED
Examination of product	Meets requirements of product drawing and AMP Specification.	Visual inspection No physical damage
<b>ELECTRICAL</b>		
Low Level Contact Resistance	30mΩ max.	Subject mated contacts assembled in housing to 20mV maximum open circuit at 100 mA maximum. EIA 364-23 (or MIL-STD-1344A, Method 3002.1, Test Condition B).
Insulation Resistance	1000MΩ min	Test between adjacent contacts of mated and unmated connector assemblies. EIA 364-21 (or MIL-STD-202F, Method 302, Test Condition B).
Dielectric Withstanding Resistance	500 V AC for one minute at sea level No creeping discharge or flashes occur.	Test between adjacent contacts of mated and unmated connector assemblies. EIA 364-20 (or MIL-STD-202F, Method 301, Test Condition B)
Contact Capacitance	2 pF Maximum per Contact	Test between adjacent circuits of unmated connector at 1 KHz. EIA 364-30
Contact Current Rating	1.5A at 250Vac minimum	When measured at an ambient temperature of 25°C. With Power applied to the contacts, the ΔT shall not exceed applied to the contacts, the 30°C at any point in the USB connector under test EIA 364-70 Method B
<b>MECHANICAL</b>		
Random Vibration	No discontinuities of 1 μ sec or longer duration	Subject mated connectors to 5.35 G's rms. Fifteen minutes in each of three mutually perpendicular planes. EIA 364-28 Test Condition V Test Letter A, (or MIL-STD-202F, Method 214, Test Condition 1, Test Letter A)
Physical Shock	No discontinuities of 1 μ sec or longer duration	Subject mated connectors to 30G's half-sine shock pulses of 11ms duration. Three shocks in each direction applied along three mutually perpendicular planes, 18 total shocks. EIA 364-27 Test Condition H (or MIL-STD-202F, Method 214B)
Durability	No mechanical defects after 1500 cycles. CR: 30mΩ max.	Mate and unmate Connector assemblies for 1500 cycles at maximum rated of 200 cycles per hour. EIA 364-09
Connector Mating Force	35 N (3.57Kgf) Max.	Measure force necessary to mate assemblies at maximum rate of 12.5mm (or 0.492") per minute. EIA 364-13

Connector Unmating Force	10 N (1.02Kgf) Min.	Measure force necessary to mate assemblies at maximum rate of 12.5mm (or 0.492") per minute. EIA 364-13
Cable Pull-out Force	Cable shall be not dislodging from cable crimp.	Apply axial load of 40 Newtons to the cable for 1 minute. EIA 364-38
<b>ENVIRONMENTAL</b>		
Thermal Shock	See note.	Subject mated connectors to five cycles between -55°C to +85°C. EIA 364-32, Test Condition I, (or MIL-202F, Method 107G Condition A.)
Humidity	See note.	Subject mated connectors to 168 Hours (seven complete cycles) EIA 364-31, Test Condition A Method III, (or MIL-202F, Method 103B Test Condition B.)
Temperature Life	See note.	Subject mated connectors to temperature life at 85°C for 250hours EIA 364-17 Test Condition 3 Method A.
<b>PHYSICAL</b>		
Solderability	The surface of the portion to be soldered shall at least 95% covered with new solder coating as specified	After one hour steam aging. EIA 364-52.

Figure 1

NOTE: Shall meet visual requirements, show no physical damages.

**3.6. PRODUCT QUALIFICATION AND REQUALIFICATION TEST SEQUENCE**

Test or Examination	Test Group			
	A	B	C	D
	Test Sequence (a)			
Examination of product	1,10	1,5	1,9	1,4
Low Level Contact Resistance	4,8	2,4		
Insulation Resistance			3,7	
Dielectric Withstanding Voltage			4,8	
Contact Capacitance			2	
Contact Current Rating				2
Random Vibration	6			
Physical Shock	7			
Durability	5			
Connector Mating Force	2			
Connector Unmating Force	3,9			
Cable Retention Force				
Thermal Shock			5	
Humidity			6	
Temperature Life		3		
Solderability				3

Figure 2

NOTE : (a) Numbers indicate sequence in which tests are performed.

单击下面可查看定价，库存，交付和生命周期等信息

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